### **DISCRETE SEMICONDUCTORS**

# DATA SHEET



## PRLL4001; PRLL4002 Rectifiers

Product specification Supersedes data of 1996 Jun 10 2003 May 13





### **Rectifiers**

### PRLL4001; PRLL4002

### **FEATURES**

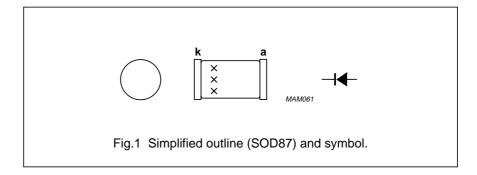
- · Glass passivated
- High maximum operating temperature
- Low leakage current
- · Excellent stability
- Shipped in 8 mm embossed tape
- Smallest surface mount rectifier outline.

### **DESCRIPTION**

Cavity free cylindrical glass package through Implotec $^{\text{TM}(1)}$  technology.

(1) Implotec is a trademark of Philips.

This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.



### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	repetitive peak reverse voltage				
	PRLL4001		_	50	V
	PRLL4002		_	100	V
V <sub>R</sub>	continuous reverse voltage				
	PRLL4001		_	50	V
	PRLL4002		_	100	V
I <sub>F(AV)</sub>	average forward current	averaged over any 20 ms period; T <sub>tp</sub> = 105 °C	_	1.60	А
		averaged over any 20 ms period; T <sub>amb</sub> = 65 °C; see Fig.2	_	0.68	А
I <sub>FRM</sub>	repetitive peak forward current		_	10	Α
I <sub>FSM</sub>	non-repetitive peak forward current	half sinewave; 60 Hz	_	20	Α
T <sub>stg</sub>	storage temperature		-65	+175	°C
Tj	junction temperature		-65	+175	°C

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### **ELECTRICAL CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; see Fig.3	1.1	V
V <sub>F(AV)</sub>	full-cycle average forward voltage	$I_{F(AV)} = 1 A$	0.8	V
I <sub>R</sub>	reverse current	$V_R = V_{Rmax}$	10	μΑ
		V <sub>R</sub> = V <sub>Rmax</sub> ; T <sub>amb</sub> = 100 °C	50	μΑ
I <sub>R(AV)</sub>	full-cycle average reverse current	V <sub>R</sub> = V <sub>RRMmax</sub> ; T <sub>amb</sub> = 75 °C	30	μΑ

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-tp</sub>	thermal resistance from junction to tie-point		30	K/W
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	150	K/W

### Note

1. Device mounted on epoxy-glass printed-circuit board, 1.5 mm thick; thickness of copper ≥40 μm, see Fig.4. For more information please refer to the "General Part of associated Handbook".

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### **GRAPHICAL DATA**

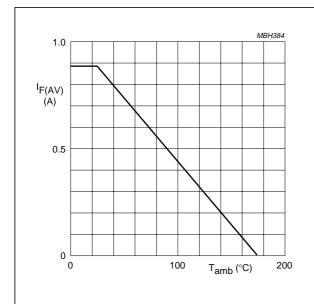
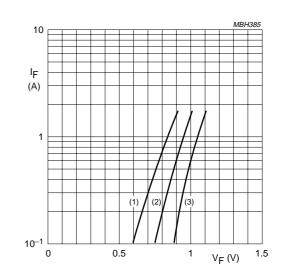
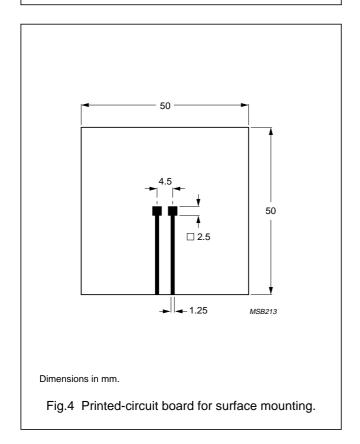


Fig.2 Maximum average forward current as a function of ambient temperature.



- (1)  $T_{amb} = 100 \, ^{\circ}C$ .
- (2)  $T_{amb} = 20 \, ^{\circ}C$ .
- (3)  $T_{amb} = -50 \,^{\circ}C$ .

Fig.3 Forward current as a function of forward voltage; typical values.



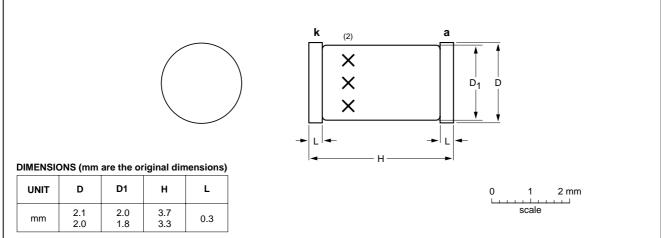
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### **PACKAGE OUTLINE**

Hermetically sealed glass surface mounted package; Implotec<sup>TM(1)</sup> technology; 2 connectors

SOD87



#### Notes

- 1. Implotec is a trademark of Philips.
- 2. The marking indicates the cathode.

OUTLINE	REFERENCES			EUROPEAN	ICCUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOD87	100H03					<del>-99-03-31</del> 99-06-04

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### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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### **DEFINITIONS**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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2003 May 13

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NOTES

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